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P1 98.2



MOS FIELD EFFECT POWER TRANSISTOR 2SK1796

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK1796 is N-channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

- Low On-state Resistance
 - $R_{DS(on)} \leqq$ 1.2 Ω (Vgs = 10 V, ID = 5 A)
- Low Ciss Ciss = 2 500 pF TYP.
- Built-in G-S Gate Protection Diode
- High Avalanche Capability Ratings

QUALITY GRADE

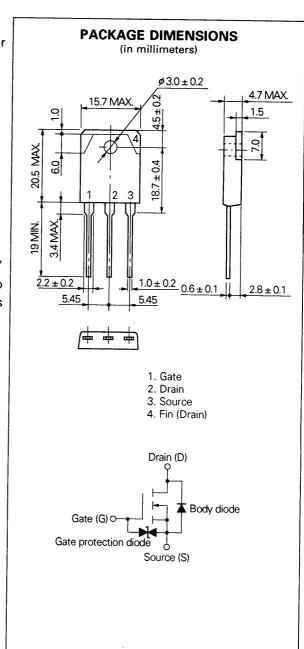
Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

Drain to Source Voltage	Voss	900	V
Gate to Source Voltage	Vgss	±30	٧
Drain Current (DC)	ID(DC)	±10	Α
Drain Current (pulse)	D(pulse)*	±20	Α
Total Power Dissipation (Tc = 25 °C)	Рт	150	W
Channel Temperature	Tch	150	°C
Storage Temperature	T _{stg} –	55 to +150	°C
Single Avalanche Current	las**	10	Α
Single Avalanche Energy	Eas**	60	mJ
* DIM < 10 D C < 4.0/			

* PW \leq 10 μ s, Duty Cycle \leq 1 %



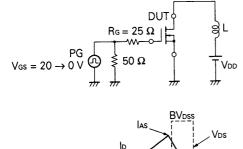
^{**} Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0



ELECTRICAL CHARACTERISTICS ($T_a = 25$ °C)

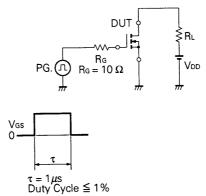
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	Ros(on)		1.0	1.2	Ω	Vgs = 10 V, lp = 5 A
Gate to Source Cutoff Voltage	V _{GS(off)}	2.5		3.5	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	y _{fs}	1.5	7.5		s	Vps = 20 V, lp = 5 A
Drain Leakage Current	loss			100	μΑ	V _{DS} = 900 V, V _{GS} = 0
Gate to Source Leakage Current	lgss			±10	μА	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Input Capacitance	Ciss		2 500		pF	V _{DS} = 10 V
Output Capacitance	Соза		370		pF	Vgs = 0
Reverse Transfer Capacitance	Crss		120		pF	f = 1 MHz
Turn-On Delay Time	td(on)		40		ns	V _{GS(on)} = 10 V
Rise Time	tr		50		ns	$V_{DD} = 150 \text{ V}$ $I_{D} = 5 \text{ A}, \text{ Rg} = 10 \Omega$ $R_{L} = 30 \Omega$
Turn-Off Delay Time	td(off)		190		ns	
Fall Time	tr		40		ns	NL = 30 12
Total Gate Charge	Qg		90		nC	Vgs = 10 V
Gate to Source Charge	Qgs		18		nC	I _D = 10 A
Gate to Drain Charge	QgD		38		nC	V _{DD} = 720 V
Diode Forward Voltage	VF(S-D)		0.9		V	I _F = 10 A, V _G s = 0
Reverse Recovery Time	trr		790		ns	I _F = 10 A
Reverse Recovery Charge	Qrr		6.6		μC	di/dt = 50 A/μs

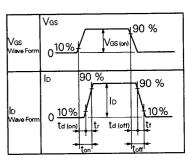
Test Circuit 1: Avalanche Capability



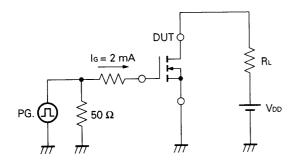
O Starting Ton

Test Circuit 2: Switching Time

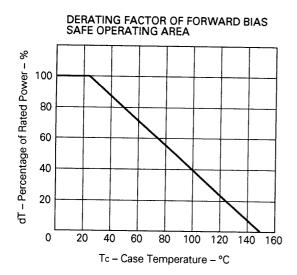


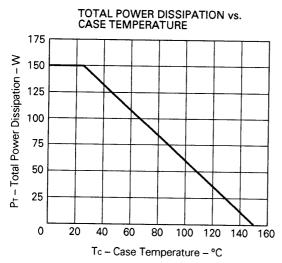


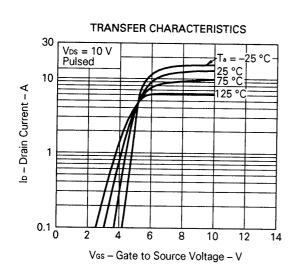
Test Circuit 3: Gate Charge

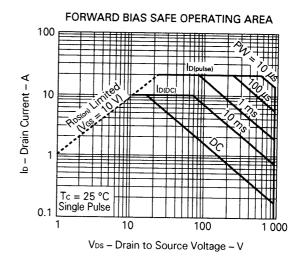


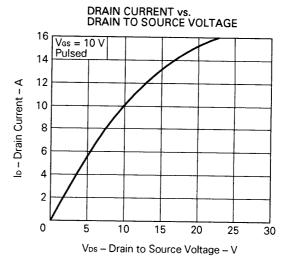
TYPICAL CHARACTERISTICS (Ta = 25 °C)



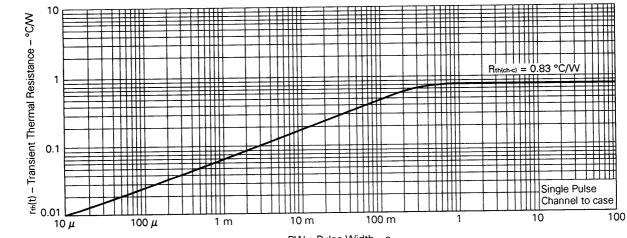






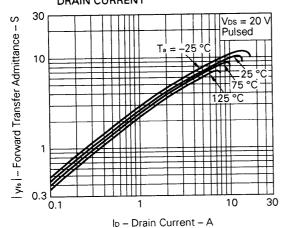


TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

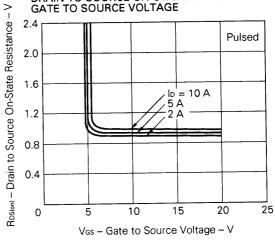


PW - Pulse Width - s

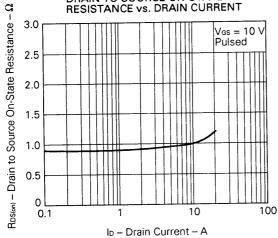
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



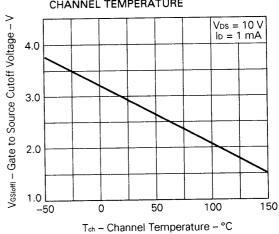
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

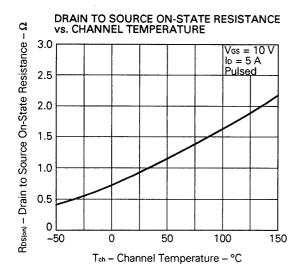


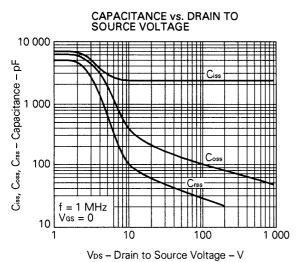
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

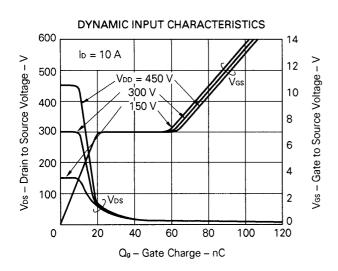


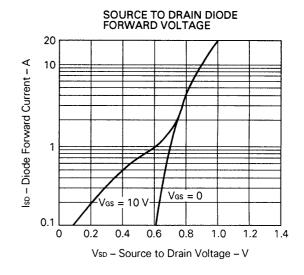
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

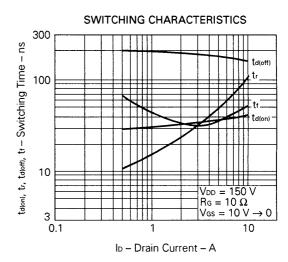


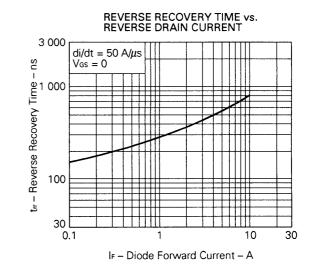




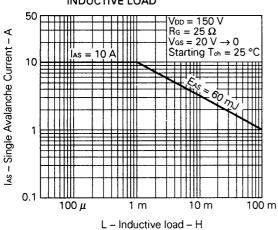




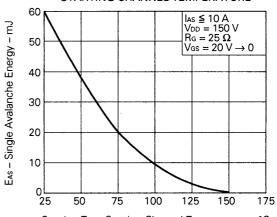




SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE



Starting Tch - Starting Channel Temperature - °C

Reference

Application note name	No.
Safe operating area of Power MOS FET.	TEA-1034
Application circuit using Power MOS FET.	TEA-1035
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207

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M4 92.6